Company Name:	EM Company
Posting Date:	31 May 2024
Category:	ITC STEM Internship Scheme
Company Overview:	Our solutions enable you to establish corporate sustainability. They are designed to create transparency along the entire value chain, fulfill legal ESG requirements and automate manual processes. Discover our software solutions tailored to the specific needs of your industry and organization. Our solutions ensure transparency and efficiency across the value chain to meet ESG regulatory requirements, drive corporate sustainability and take your corporate ESG strategy to the next level.
Position/Title:	Position 1: Data Analysis Position 2: Software Engine
Proposed Internship Duration:	90 days
Job Description & Requirements:	Position 1: Data Analysis Job Description: - Experience as Data Analyst in Financial Service Industry/Banking Industry or contruction - Strong experience in requirements engineering. Able to perform user story preparation, determine workflow, and give recommendations on process enhancements and system upgrades. - Proven knowledge and experience with Agile methodologies including SAFe, Kanban and scrim as well as traditional waterfall methodologies Job Requirements: - Familiarity with Java - Excellent analytical and problem-solving skills with technical understanding - Solid business analysis skills to elicit and document requirement - Solid communication skills to liaise with the business stakeholder and the technical team - Clear understanding of software development cycle No. of vacancies: 3
Job Description & Requirements:	Position 2: Software Engine Job Description and Requirements: - Greenfield development and the continuous improvement of our existing systems. - Develop RESTful APIs and event driven microservices using Kafka. - Use Kubernetes and Docker to schedule and run microservices. - Write high quality, maintainable code using TDD. - Our technology stack is predominantly Kotlin / Java, but our architecture allows for using the most appropriate language to solve a given problem. - PostgreSQL, Aurora and S3 for persistence. - Leverage our elastic AWS infrastructure. - Practice continuous integration and delivery. - Preferably fluent with Kotlin and/or Java. - Solid experience in back-end development and CI/CD processes.

	• Ideally experienced with AWS development environment. • Quick learner with an ambitious and results driven personality. • Work well as part of a team in a fast-paced environment. • Excellent communication and organisational skills. No. of vacancies: 3
Internship Period:	Summer Term 2024 Full-time placements with a duration of no less than 4 consecutive weeks (28 calendar days)
How to Apply:	**Please read the application guidelines to ensure that you could fulfill the scheme requirements prior to applying for the intern(s).** Interested students should submit your application directly to the employer with your CV at your earliest convenience. Email to efcompany733@gmail.com Application Deadline: Position 1: 31/07/2024 Position 2: 01/07/2024
Salary / Hourly Rate:	HK$11,190 per month, capped at three months (i.e. 90 days, maximum at HK$33,570) in one academic year under ITC STEM Internship Scheme For Summer 2024 Internships, the allowance is estimated to be disbursed in December 2024.

Once confirm the internship offer:	Student interns who confirm the internship offer are required to*:
	   (1) submit declaration form which is available on SDSC's website **before the commencement of internship**;
	   (2) declare as "Student Interns" or "Work Experience Students" if applicable for exemption of minimum wage requirement **before the commencement of internship**;
	   (3) report to SDSC via online registration form with supporting document(s) **before the commencement of internship**;
	   (4) submit the duly completed **Assessment/Evaluation Form** to SDSC for processing the allowance **upon completion of the whole internship period or the submission deadline, whichever is earlier**.
	
	Details please refer to the email "Internship - Guidelines and Procedures (Summer Term 2024)" sent on 17 May 2024